

# Transverse, axial and torsional strain in REBCO tapes; experiments and model

A. Nijhuis<sup>1</sup>, K. Ilin<sup>1</sup>, K. A. Yagotintsev<sup>1</sup>, P. Gao<sup>1</sup>, J. Kosse<sup>1</sup>, W. A. J. Wessel<sup>1</sup>,  
S. Otten<sup>1</sup>, V.A. Anvar<sup>2</sup>, C. Zhou<sup>3</sup>, T.J. Haugan<sup>4</sup>, D.C. van der Laan<sup>5</sup>



<sup>1</sup> University of Twente, Faculty of Science & Technology, The Netherlands

<sup>2</sup> T K M College of Engineering, Kollam, Kerala, India

<sup>2</sup> ITER International Organisation, Cadarache, France

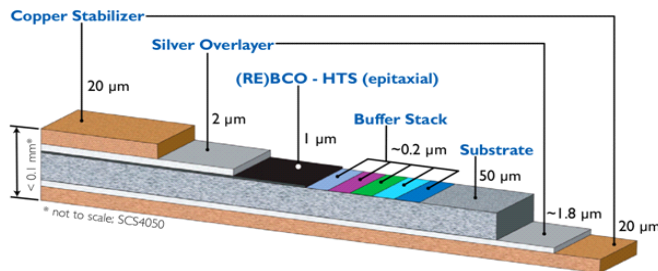
<sup>3</sup> US Air Force Research Laboratory, USA

<sup>4</sup> Advanced Conductor Technologies and University of Colorado, USA



# Outline

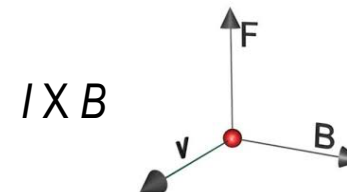
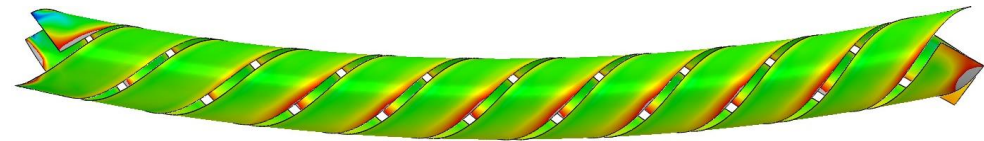
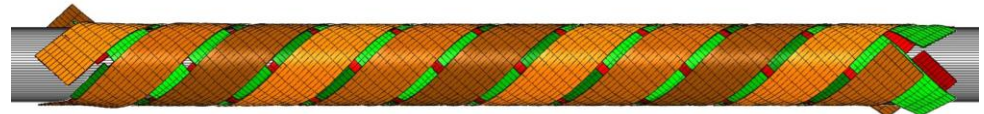
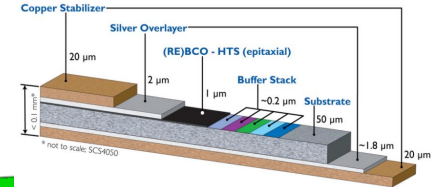
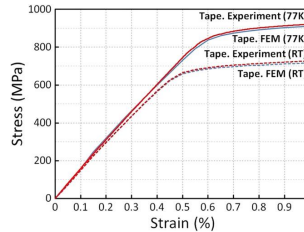
- Introduction
- Tape model and experiments
- CORC cable model, work in progress
- Summary



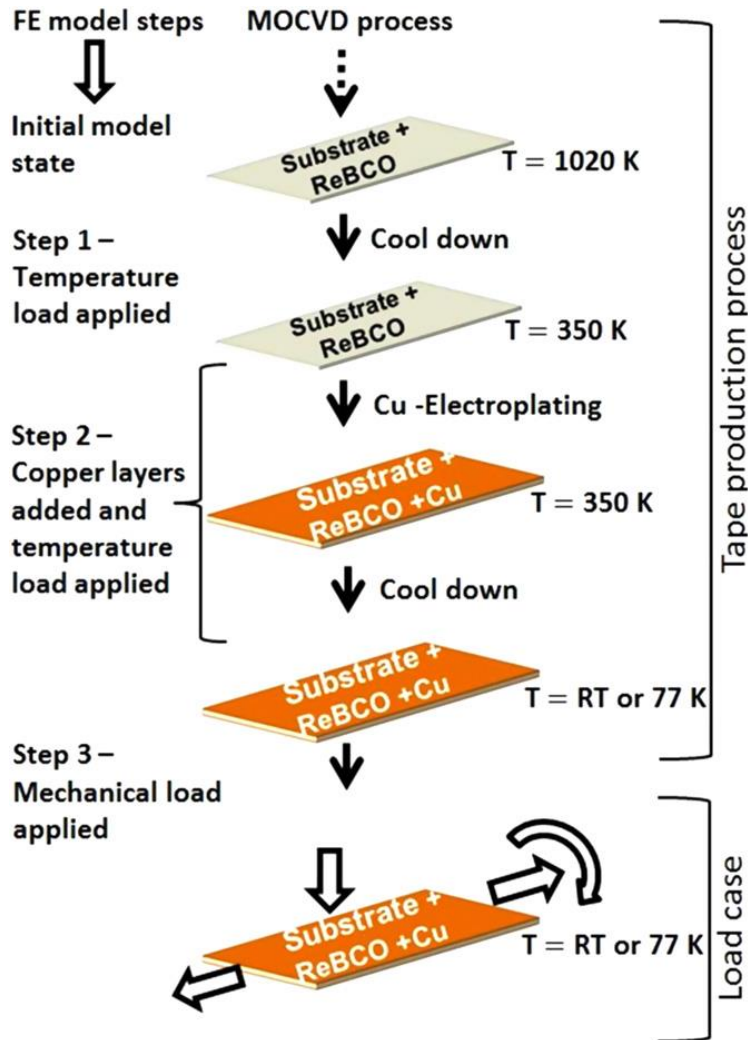
All samples - SuperPower SCS 4050 tape

# CORC cable FE modeling steps

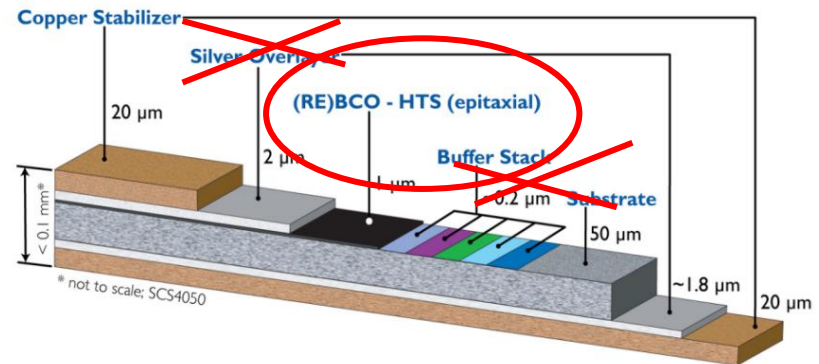
- Step 1** • Tape material thermal-mech. properties
- Step 2** • Tape production (different  $T$  process)
- Step 3** • Tape winding to CORC @ RT
- Step 4** • CORC bending to coil @ RT
- Step 5** • Cooling to operating  $T_{op}$  (77 K)
- Step 6** • Electromagnetic load @  $T_{op}$



# Modeling tape from initial state



- Substrate (Hastelloy C-276)
  - Copper (Electroplating)
  - REBCO
- Buffer and silver layers excluded from model (minor influence on tape mechanical behavior)

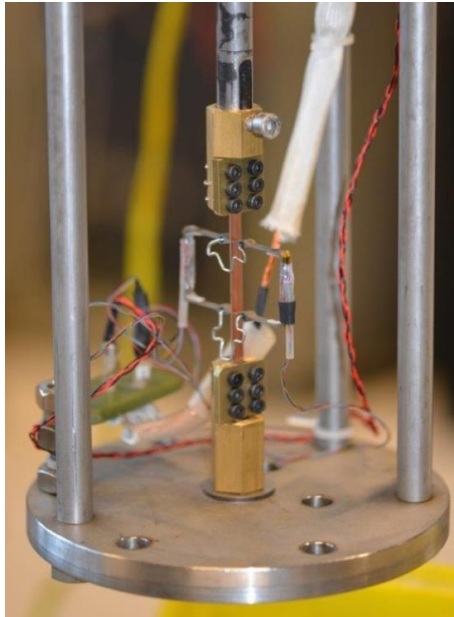


Model: residual strain in REBCO layer at RT – 0.17 %.

Cooling down to 77 K increases compressive strain further to  $\sim -0.24\%$ .



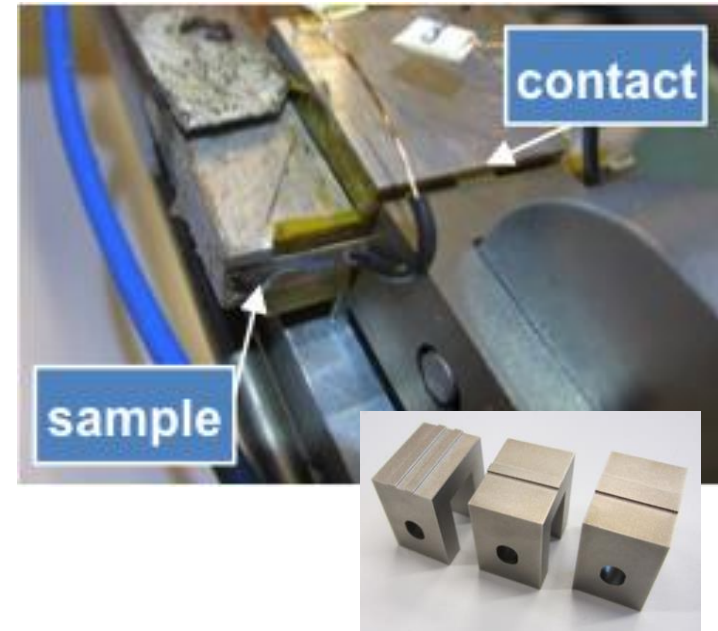
# Tape strain test setups



Tensile axial stress-strain for thermo-mechanical material properties of tape components (copper, hasteloy)



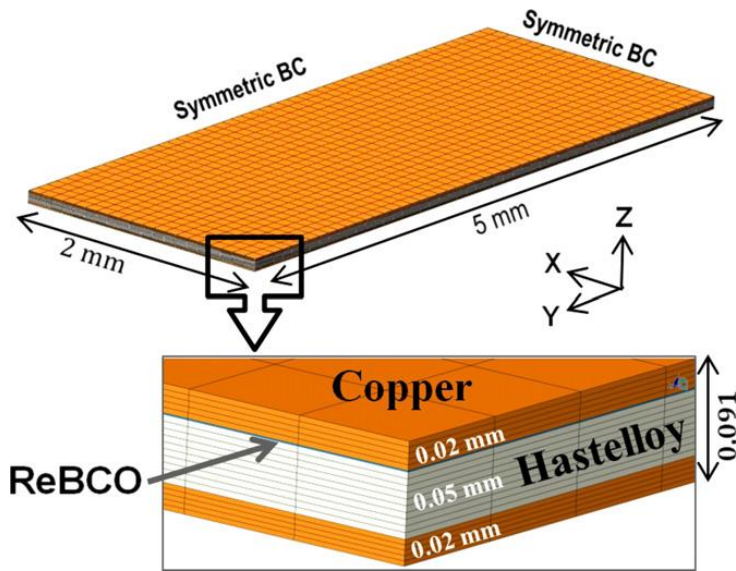
Combined controlled torsion + tensile axial stress



Transverse stress with different loading profiles

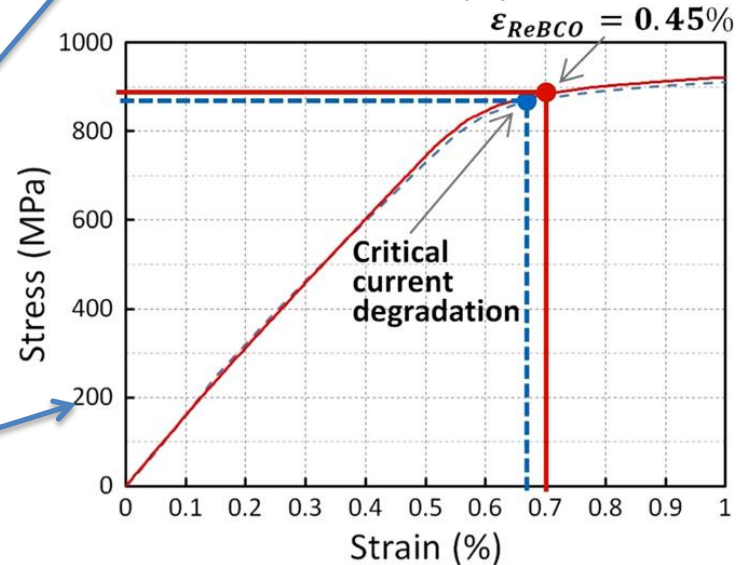
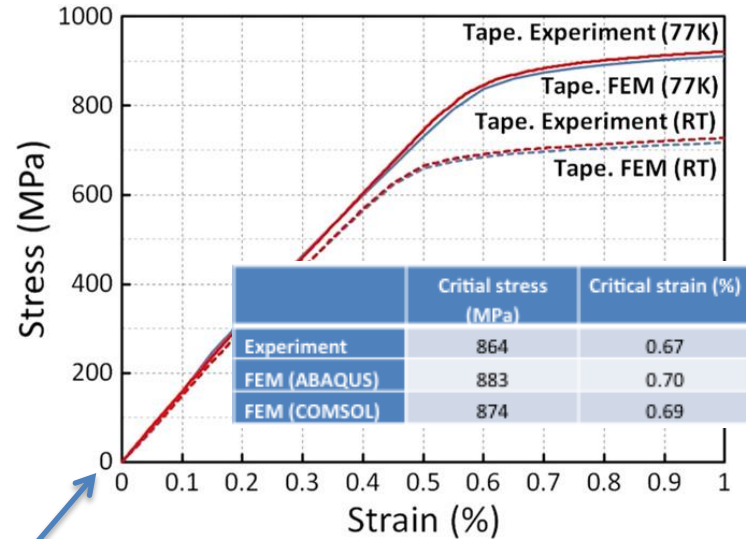
# Simulation and experiment: tensile

Geometry: FE mesh and boundary conditions



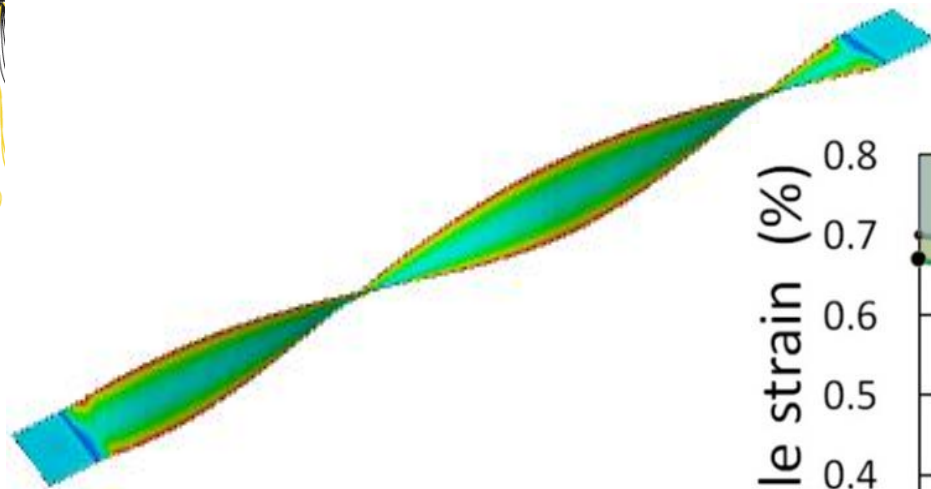
After exp. determining copper & Hastelloy properties, good agreement tensile load experiments and modeling results at RT and 77 K.

Critical intrinsic tensile strain = 0.45%. (neutron diffraction experiment K. Osamura et al.). Results **FEM** and **experiment** at 77 K.



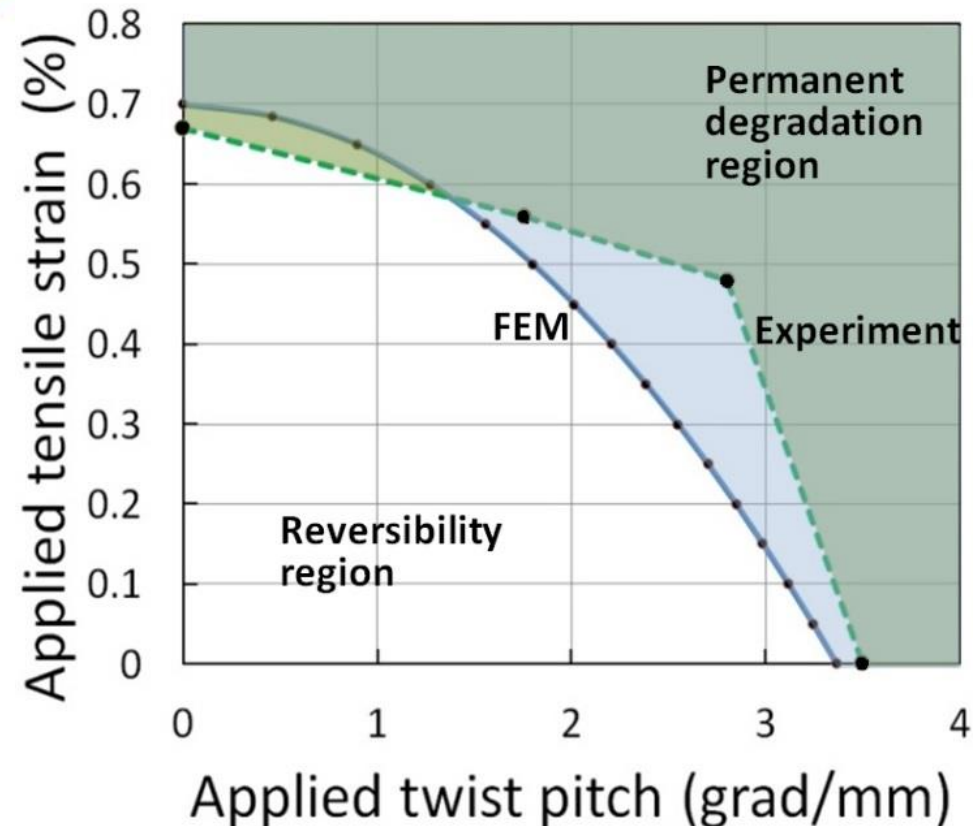
# Simulation and experiment: tensile + torsion

FEM simulation: Tensile + Torsion at 77 K, with longitudinal strain in REBCO layer



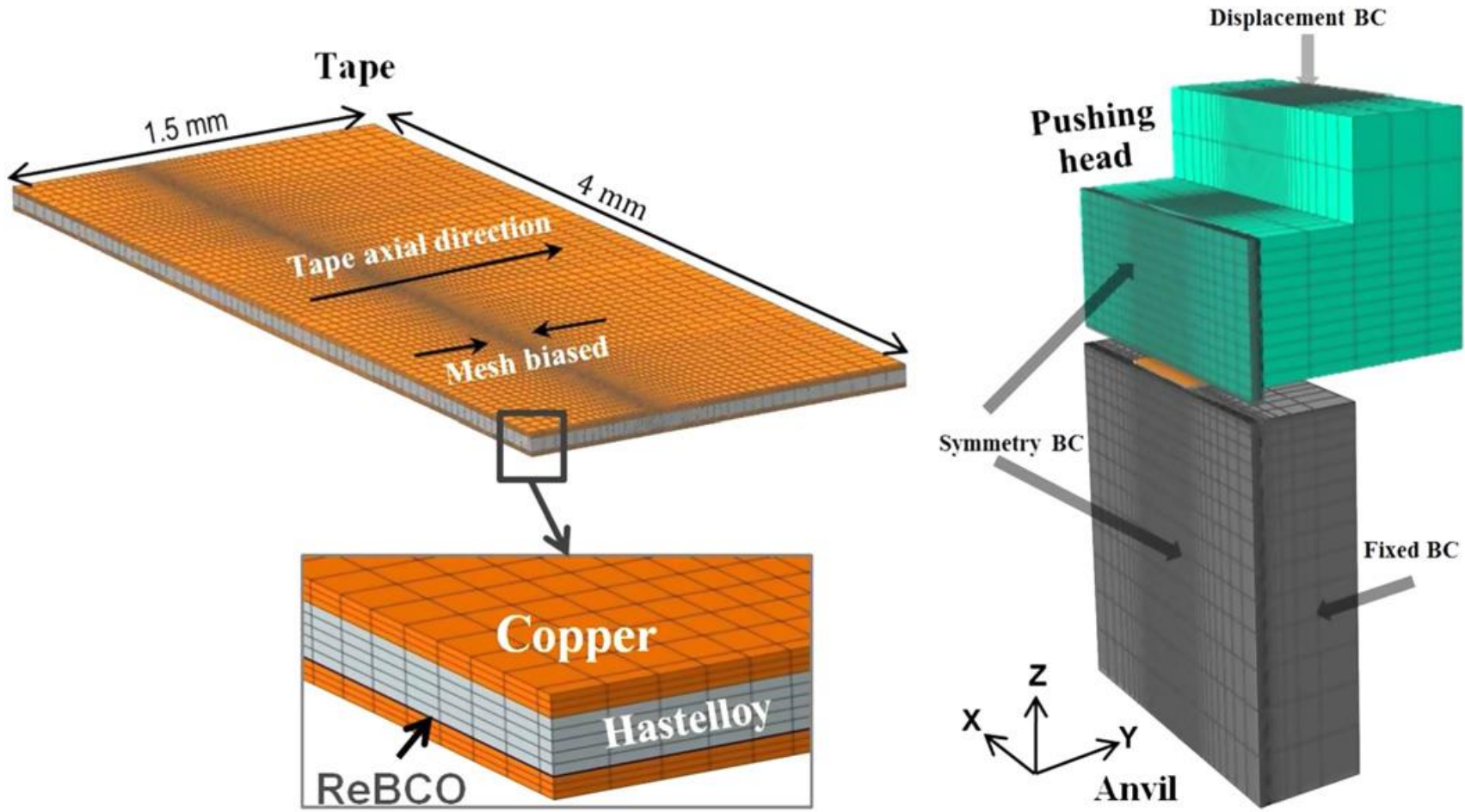
FEM computation: critical strain in REBCO layer as a function of applied external tensile strain and applied torsion strain at 77 K

Experimental:  $I_c$  measurement with 10  $\mu\text{V/m}$  criterion (less sensitive with increasing torsion)





# FEM transverse load

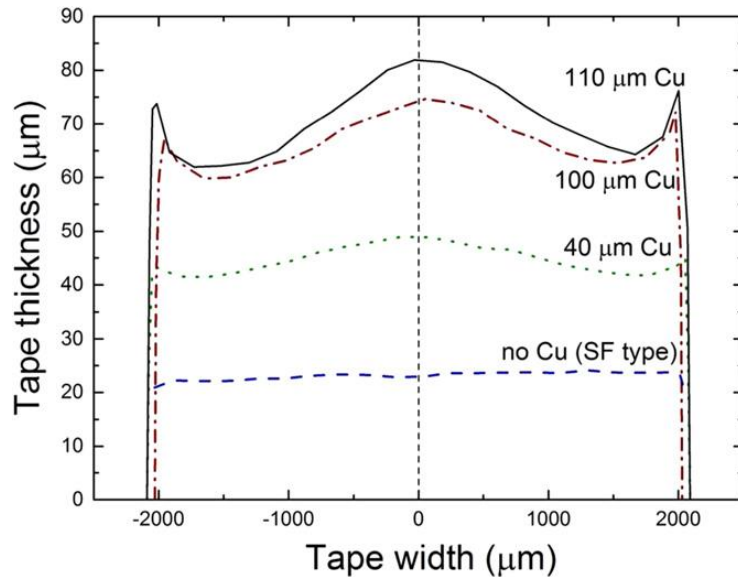


Extensive FE mesh of tape, anvil and pushing head, since deformation of all parts is important



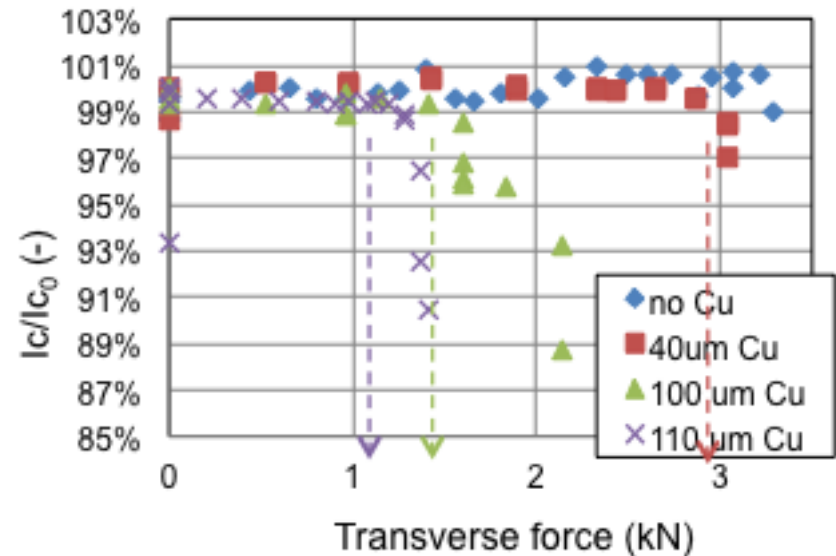
# Tape thickness variation, transverse stress

SEM analysis of tape thickness



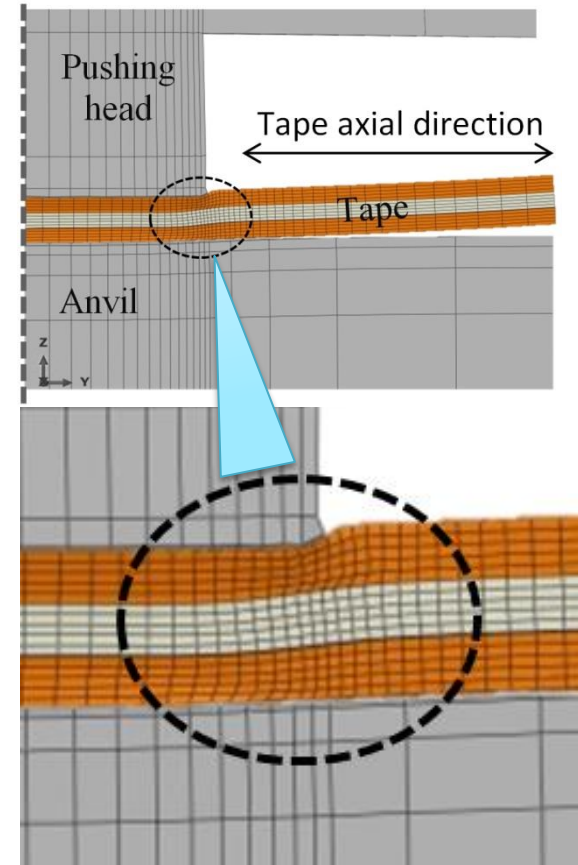
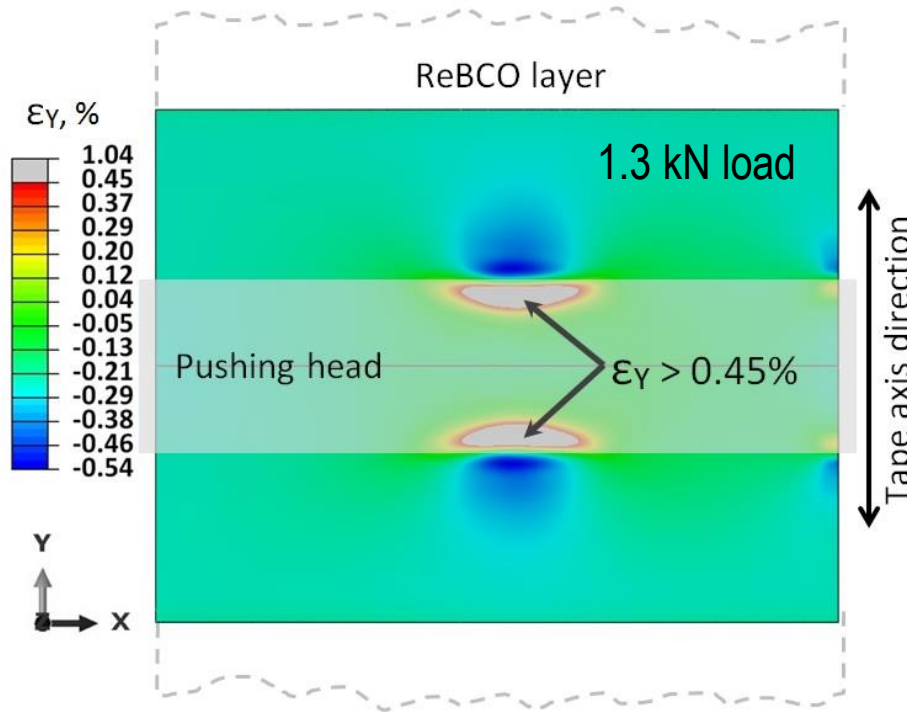
4 mm pushing head (40 µm Cu)

$I_c$  degradation vs tape thickness



- Copper thickness not uniform over tape width.
- How much is influence of copper thickness, how much of inhomogeneity?

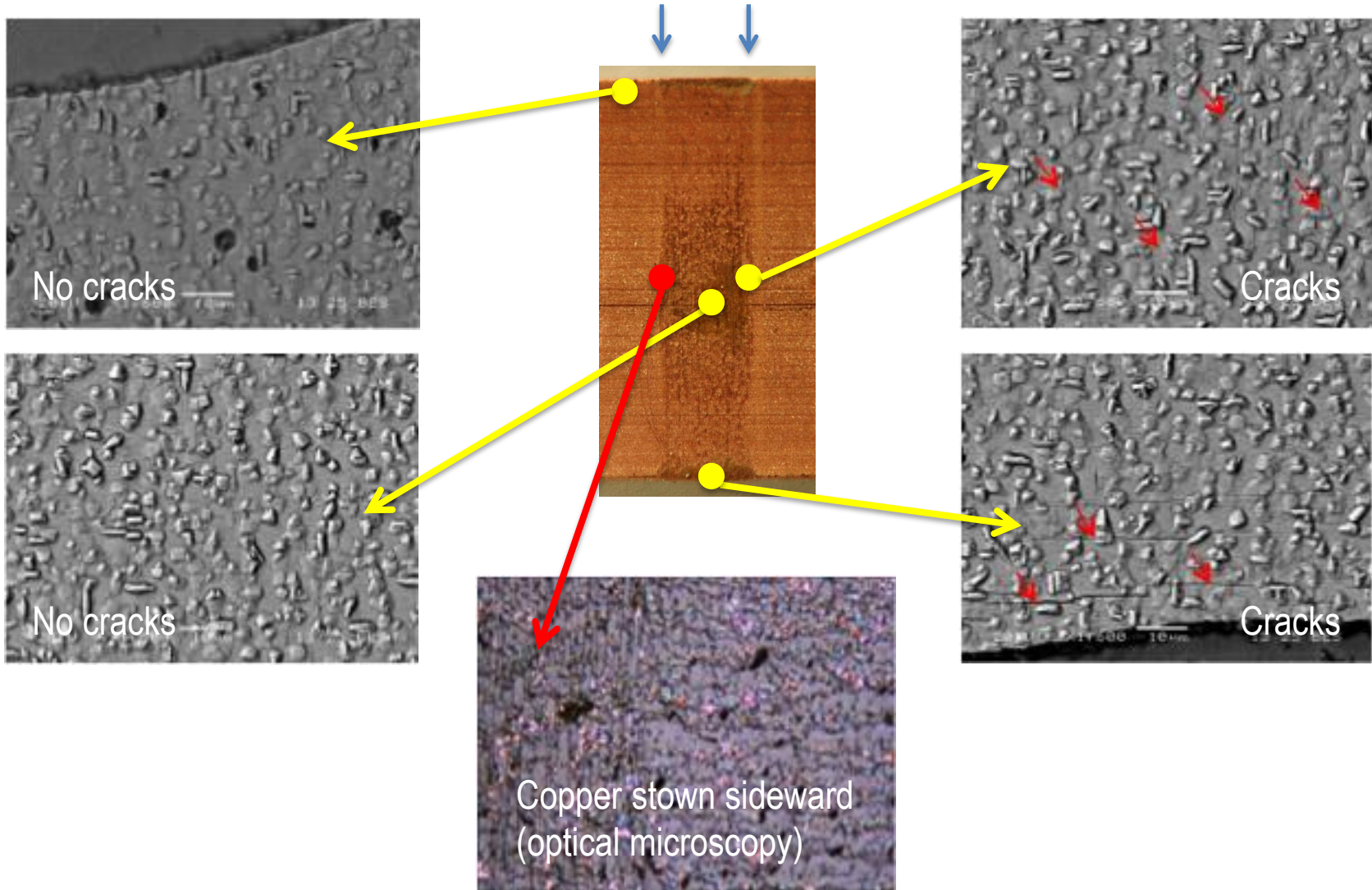
# FEM transverse load, thickness copper



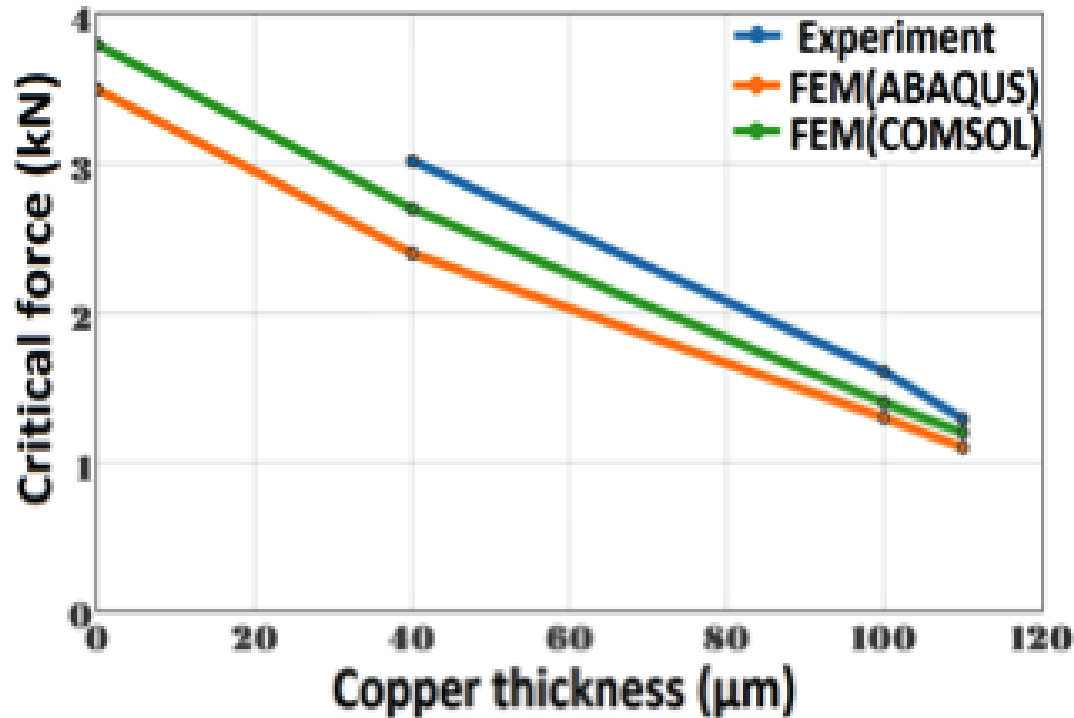
In plane strain in REBCO layer calculated using 100  $\mu\text{m}$  copper thickness.

- The strain concentration areas are localized at boundaries of the pushing head
- Copper starts flowing in outward direction, increasing strain in REBCO plane

# Transverse stress SEM micrographs



# Transverse load, FEM versus experiment

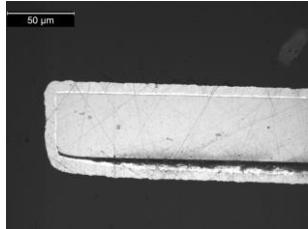


Critical force as a function of copper layer thickness at 77K. FEM model and experimental results.

Measured Cu thickness profiles are used for FEM computation

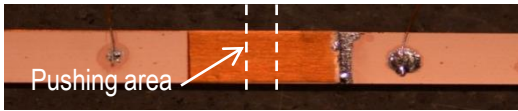


# Transverse load: Cu thickness & profiles

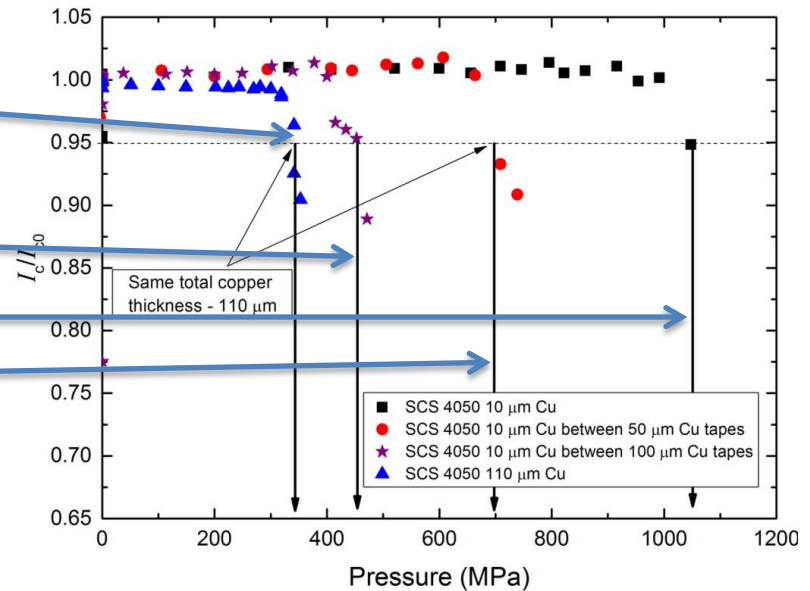
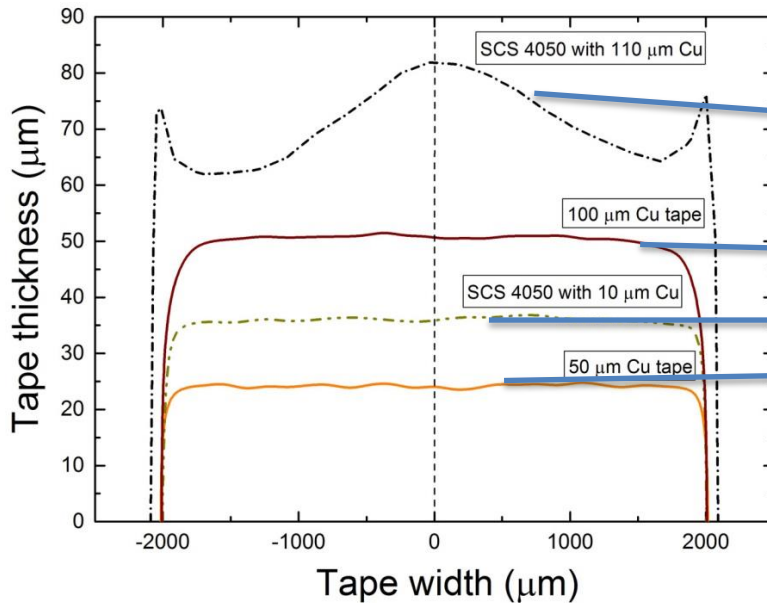


50 μm Cu tape  
100 μm Cu tape

Super power<sup>®</sup> 2G SCS4050 with 10 μm Cu layer

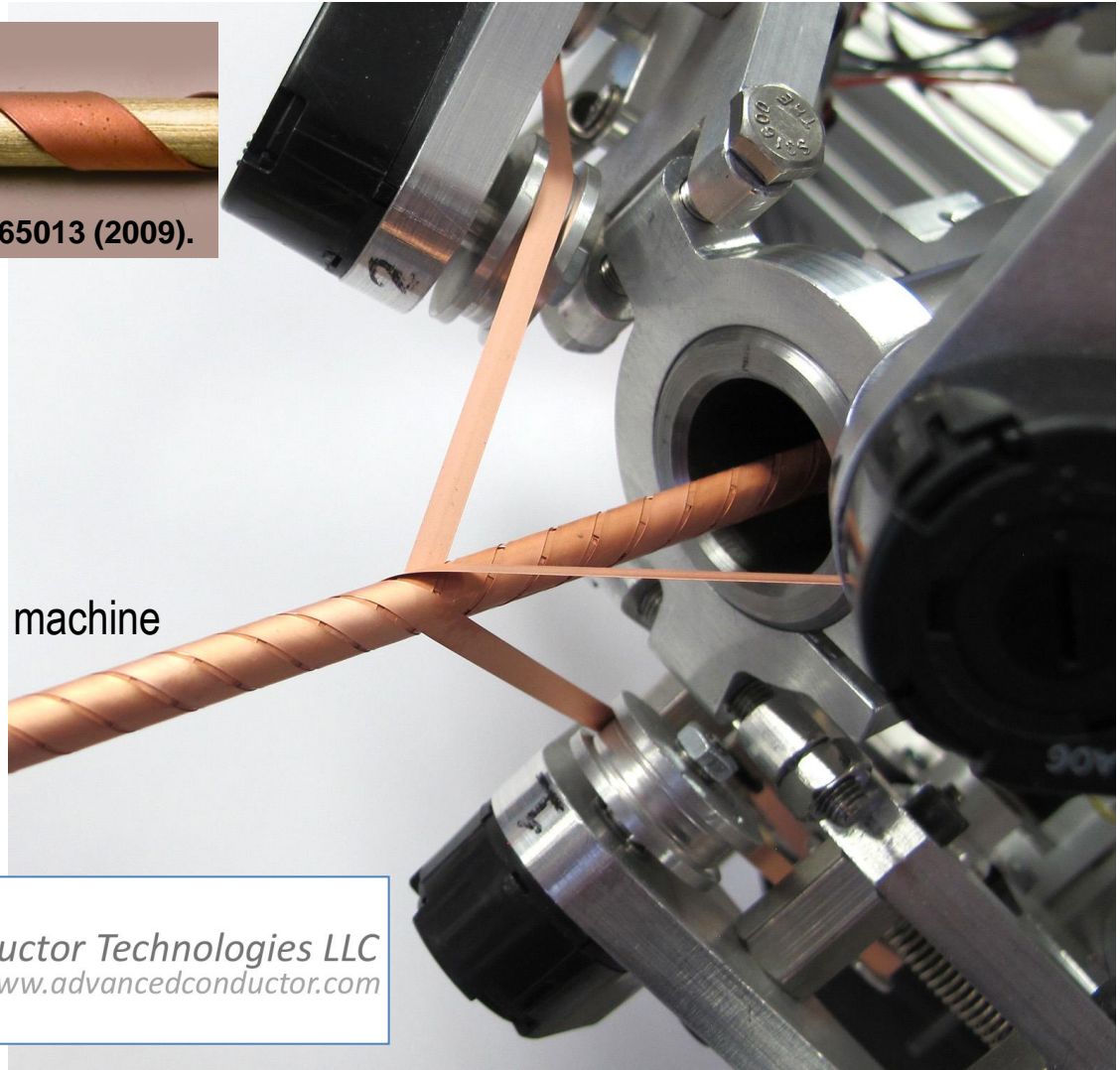
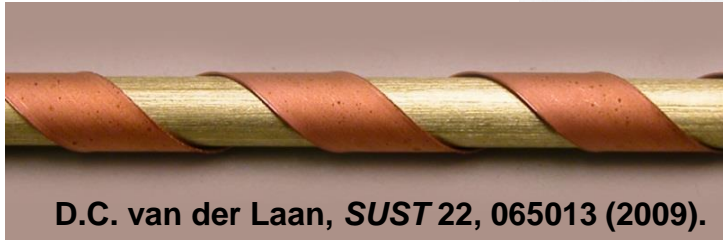


No “dog boning” effect, uniform tape thickness is over width.



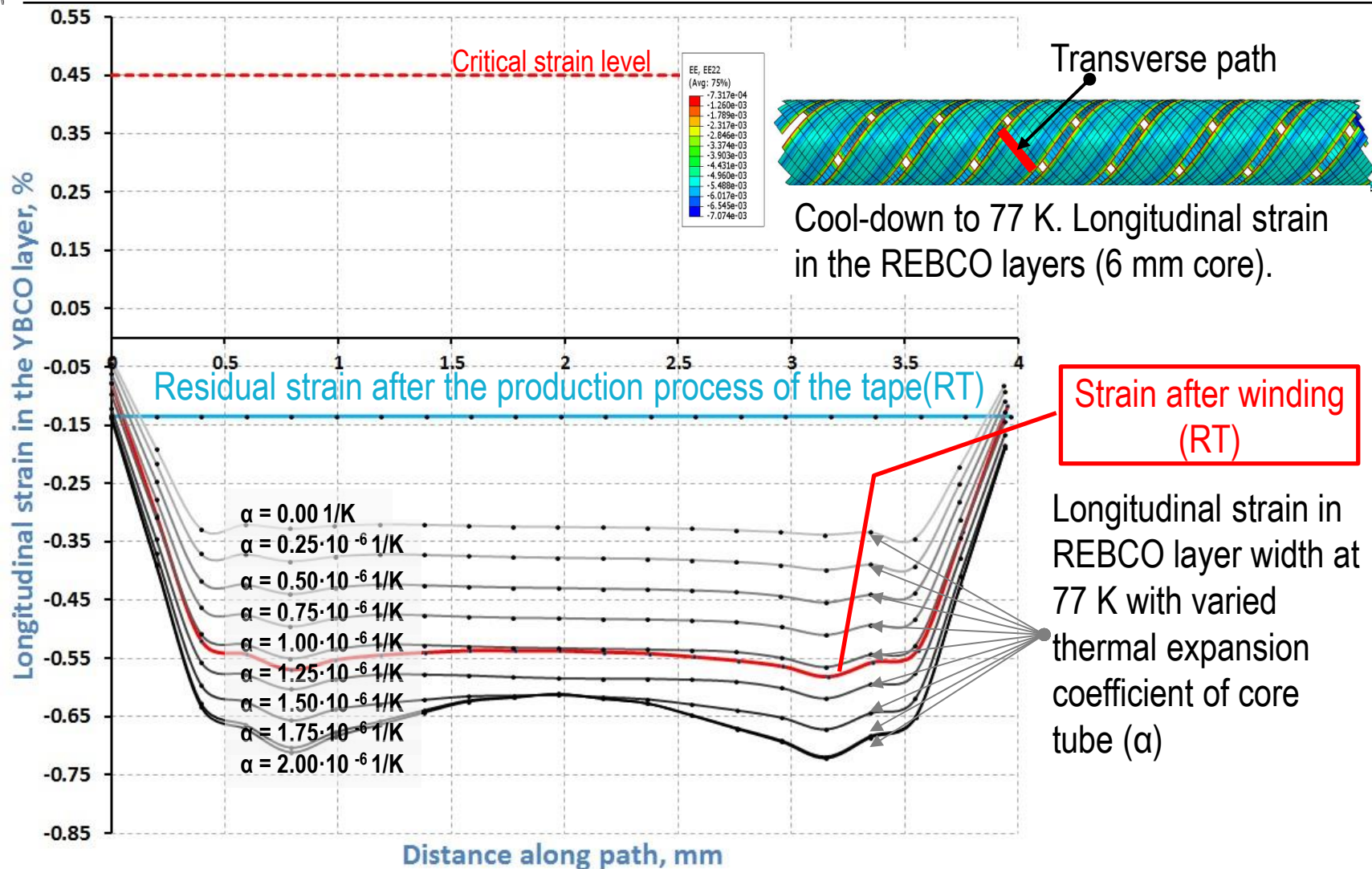
Both, copper layer thickness and surface homogeneity play a role, thickness-Cu most.

# CORC cable



*Advanced Conductor Technologies LLC*  
[www.advancedconductor.com](http://www.advancedconductor.com)

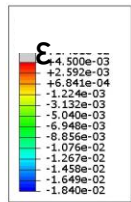
# CORC cable FE modeling: cool down



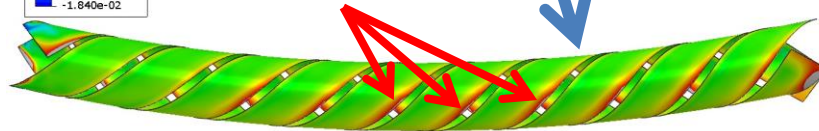


# Bending one layer CORC cable (3 tapes)

Cable bending radius  
 $R = 200$  mm

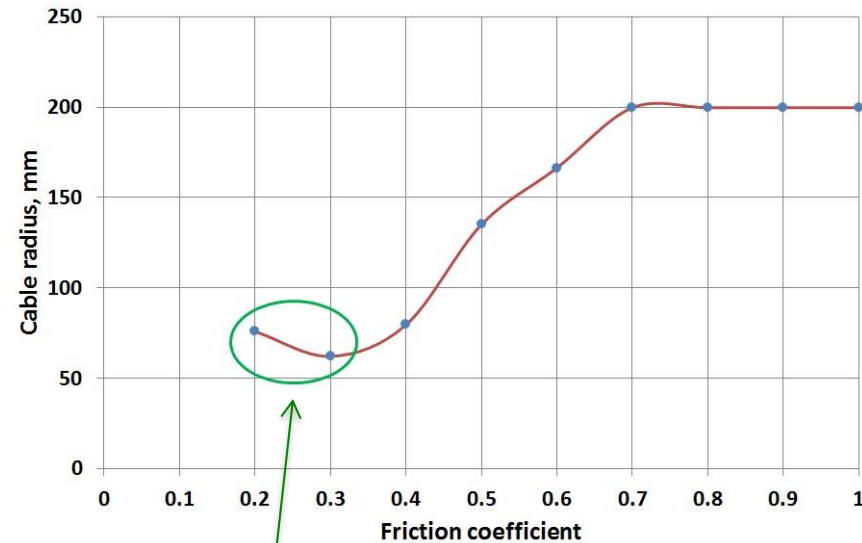


$\epsilon_{irr} = 0.45\%$



Strain along tape direction in REBCO at  
 cable radius  $R = 200$  mm and  $\mu = 1$   
 (cable core 6 mm)

Variable parameter:  
 $\mu$  – friction coefficient tape-core interface



Bending  $R$  for  $\epsilon=0.45\%$  versus friction coefficient

For  $\mu = 0.2$  and  $0.3$  no convergence reached in computation

Work in progress .... but use of lubricant to reduce  $\mu$  seems a good idea ...

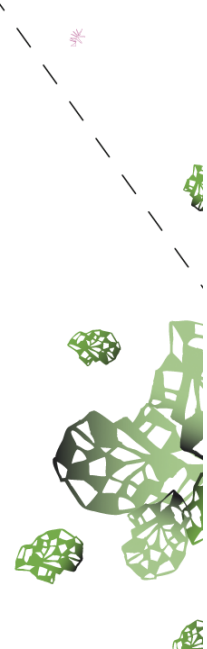




# Summary

---

- Systematic studies performed on SCS4050 REBCO tape under tensile, torsion and transverse load.
- Tape FE model validated against experiments.
- Homogeneity of tape surface but mostly thickness of copper layer plays significant role in allowable transverse peak load.
- CORC modeling in progress for tape/cable/core optimization.



K Ilin, K A Yagotintsev, C Zhou, P Gao, J Kosse, S J Otten, W A J Wessel, T J Haugan, D C van der Laan, and A Nijhuis, "Experiments and FE modeling of stress–strain state in ReBCO tape under tensile, torsional and transverse load", *Supercond. Sci. Technol.* 28 (2015) 055006 (17pp) doi:10.1088/0953-2048/28/5/055006